

PATENT 0152-0551P

## IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

ARIYASU, Hideyuki et al. Conf.:

7701

Appl. No.:

09/773,627

Group:

1773

Filed:

February 2, 2001

Examiner: Kruer, Kevin

For:

THERMOPLASTIC RESIN INTEGRATED

STRUCTURE

LARGE ENTITY TRANSMITTAL FORM

TC 1700

June 30, 2003

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith is an amendment in the above-identified application.

The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.

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The fee has been calculated as shown below:

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR		PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	59	-	60	=	0	\$ 18	\$0.00
INDEPENDENT	2	-	3	11	0	\$ 84	\$0.00
FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$280	\$0.00
						TOTAL	\$0.00

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		nonth(s) extension of time pursuant to 1.136(a). \$0.00 for the extension of					
$\boxtimes$	No fee is required.						
	Check(s) in the amount of \$0.00 is(are) enclosed.						
	Please charge Deposit A \$0.00. This form is sub	Account No. 02-2448 in the amount of mitted in triplicate.					
overprequi	urrent, and future repli payment to Deposit Accou	ssioner is hereby authorized in this, ies, to charge payment or credit any nt No. 02-2448 for any additional fees 1.16 or under 37 C.F.R. § 1.17; ime fees.					
		Respectfully submitted,					
		BIRCH, STEWART, KOLASCH & BIRCH, LLP					
		Baymond C. Stewart, #21,066					
•	WJR:bmp -0551P	P.O. Box 747 Falls Church, VA 22040-0747 (703) 205-8000					

Attachment(s)

(Rev. 04/30/03)